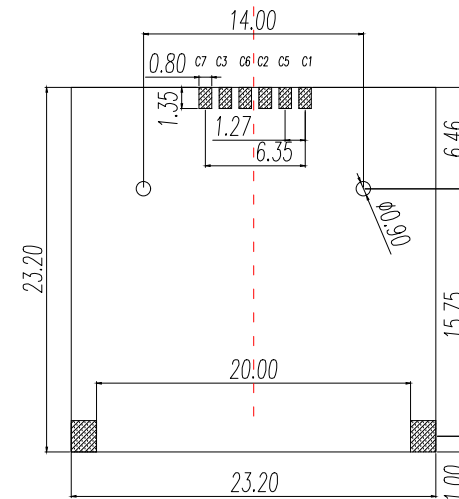
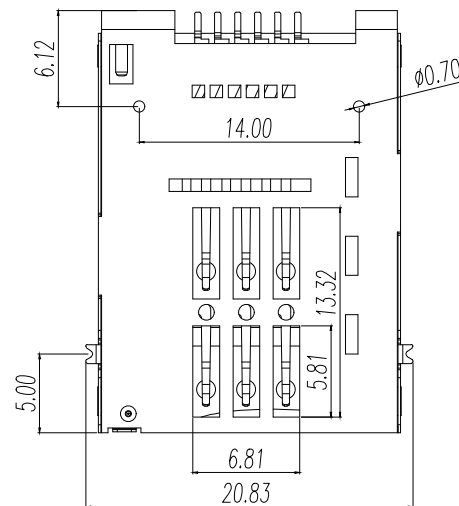
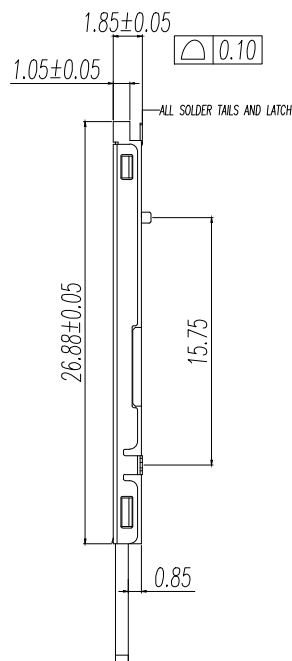
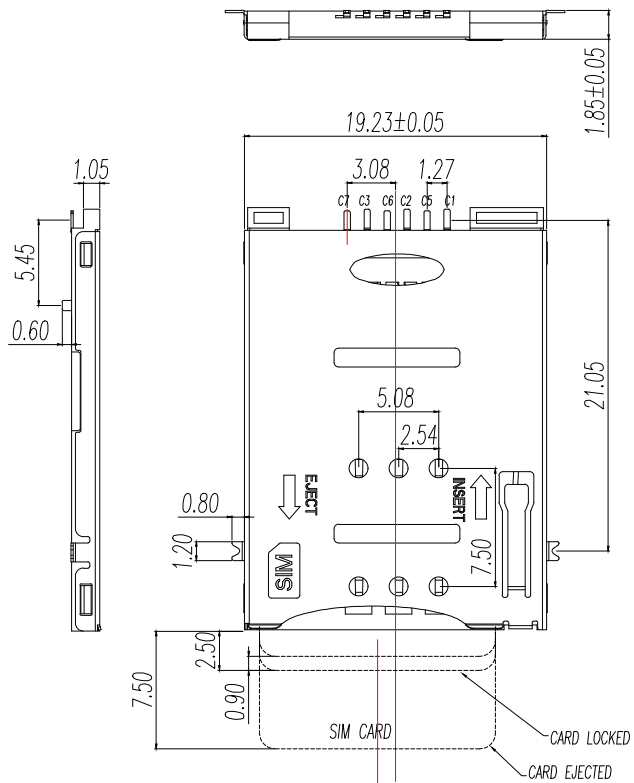
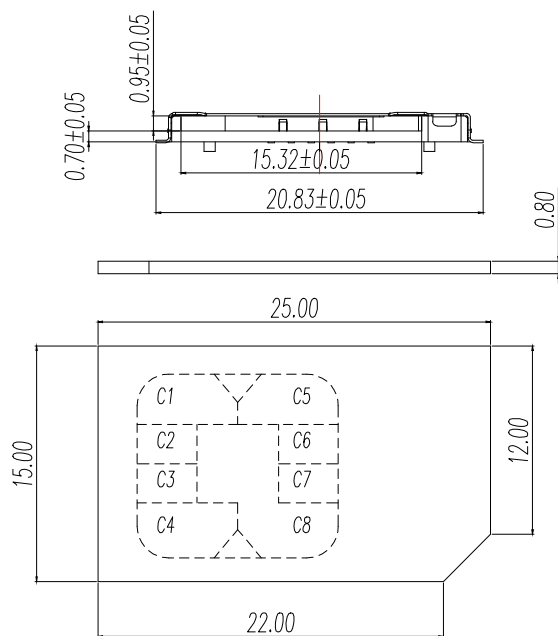




▨ PAD AREA  
■ KEEP OUT AREA  
RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ±0.05

- 1.SPECIFICATIONS  
INSULATION RESISTANCE: 500M min.AT DC 500V DC  
WITHSTANDING VOLTAGE: 250V ACrms FOR 1 MINUTE  
CONTACT RESISTANCE: 100M max. AT 10MA/20mV max  
CURRENT RATING: 0.5A  
VOLTAGE RATING: 5.0 vrms  
OPERATING TEMP.RANGE:-55℃ ~ +85℃  
MATING CYCLES: 5000 INSERTIONS
- 2.MATERIAL:  
INSULATOR: H-TEMPERATURE PLASTIC,UL 94V-0,  
COLOR"BLACK  
TERMINAL: COPPER ALLOY,T=0.15mm  
SHELL: STAINLESS STEEL,T=0.15mm
- 3.FINISH:  
TERMINAL:50u" min NICKEL UNDERPLATED ON ALLOVER,GOLD PLATING  
ON CONTACT ARER, 80u"min TIN ON SOLDER TAIL.  
SHELL:50u" NICKEL UNDERPLATED ON ALLOVER, GOLD FLASH ON SOLDER  
LATCH

| MINI SIM CARD |            |
|---------------|------------|
| Pin No.       | NAME       |
| C1            | VCC OF SIM |
| C2            | RST OF SIM |
| C3            | CLK OF SIM |
| C5            | GND OF SIM |
| C6            | VPP OF SIM |
| C7            | I/O OF SIM |
| C4/C8         | N/A        |



| 制图<br>DRAWN | 变更内容<br>DESCRIPTION | 日期<br>DATE | GENERAL TOLERANCE |        | 审核<br>CHECK | 批准<br>APPROVAL | 单位<br>UNITS | 比例<br>SCALE | 1:1 | 料号<br>PART NO. | 品名<br>TITLE | 客户料号<br>CUTM.NO. | 版本<br>REV. | 页次<br>SHEET | A |
|-------------|---------------------|------------|-------------------|--------|-------------|----------------|-------------|-------------|-----|----------------|-------------|------------------|------------|-------------|---|
|             |                     |            | X.±0.25           | X."±1" |             |                |             |             |     |                |             |                  |            |             |   |
|             |                     |            | .X±0.10           |        |             |                |             |             |     |                |             |                  |            |             |   |
|             |                     |            | .XX±0.05          |        |             |                |             |             |     |                |             |                  |            |             |   |
|             |                     |            |                   |        |             |                |             |             |     |                |             |                  |            |             |   |

|      |                  |                                |             |     |
|------|------------------|--------------------------------|-------------|-----|
| EMMA | 料号<br>PART NO.   | BX-SIM-1.85H6PJ                | 版本<br>REV.  | A   |
| EVA  | 品名<br>TITLE      | MINI SIM CARD PUSH PUSH 6P SMT | 页次<br>SHEET | 1/1 |
| JADE | 客户料号<br>CUTM.NO. |                                |             |     |
|      |                  |                                |             |     |

MM 比例 SCALE 1:1

**Bossie (博锡)**